SN54ABT2952, SN74ABT2952 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

SCBS202 - NOVEMBER 1990 - REVISED OCTOBER 1992

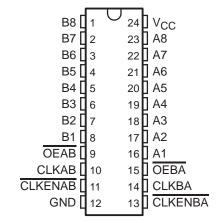
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Two 8-Bit Back-to-Back Registers Store Data Flowing in Both Directions
- Noninverting Outputs
- Typical V_{OLP} (Output Ground Bounce)
 1 V at V_{CC} = 5 V, T_A = 25°C
- Package Options Include Plastic Small-Outline (SOIC) and Shrink Small-Outline (SSOP) Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs

description

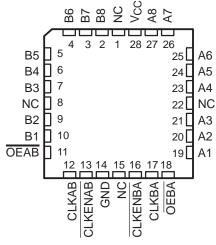
The 'ABT2952 consists of two 8-bit back-to-back registers that store data flowing in both directions between two bidirectional buses. Data on the A or B bus is stored in the registers on the low-to-high transition of the clock (CLKAB or CLKBA) input provided that the clock-enable (CLKENAB or CLKENBA) input is low. Taking the output-enable (OEAB or OEBA) input low accesses the data on either port.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54ABT2952 . . . JT PACKAGE SN74ABT2952 . . . DB, DW, OR NT PACKAGE (TOP VIEW)



SN54ABT2952 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN74ABT2952 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54ABT2952 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT2952 is characterized for operation from –40°C to 85°C.

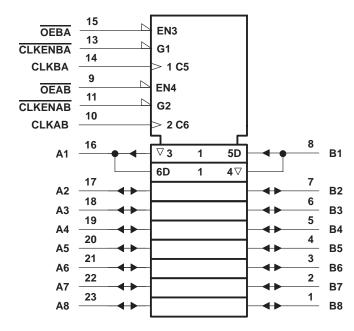
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FUNCTION TABLE[†]

	OUTPUT			
CLKENAB	CLKAB	OEAB	Α	В
Н	Х	L	Χ	В ₀ ‡ В ₀ ‡
Х	H or L	L	Χ	в ₀ ‡
L	\uparrow	L	L	L
L	\uparrow	L	Н	Н
Х	X	Н	Χ	Z

[†] A-to-B data flow is shown; B-to-A data flow is similar but uses CLKENBA, CLKBA, and OEBA.

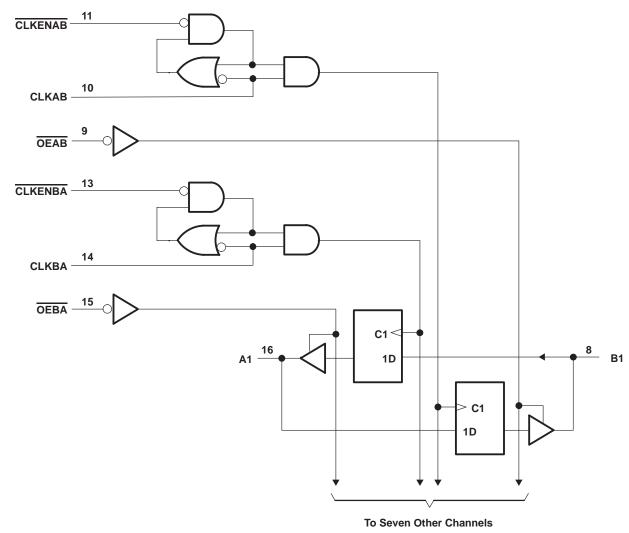
logic symbol§



\$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DB, DW, JT, and NT packages.

[‡]Level of B before the indicated steady-state input conditions were established.

logic diagram (positive logic)



Pin numbers shown are for the DB, DW, JT, and NT packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	0.5 V to 7 V
Voltage range applied to any output in the high state or	r power-off state, VO0.5 V to 5.5 V
Current into any output in the low state, Io: SN54ABT2	2952 96 mA
SN74ABT2	2952
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air):	DB package 0.7 W
	DW package 1 W
	NT package 1.3 W
Storage temperature range	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



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recommended operating conditions (see Note 2)

				T2952	SN74AB	LINUT	
			MIN	MAX	MIN	MAX	UNIT
V _{CC} Supply voltage				5.5	4.5	5.5	V
VIH	VIH High-level input voltage				2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
٧ _I	Input voltage			Vcc	0	Vcc	V
lOH	OH High-level output current			-24		-32	mA
loL	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 2: Unused or floating pins (input or I/O) must be held high or low.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS			1	Γ _A = 25°(3	SN54AB	T2952	SN74ABT2952		
				MIN	TYP [†]	MAX	MIN	MAX	MIN	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V}, \qquad I_{I} = -18 \text{ mA}$					-1.2		-1.2		-1.2	V
	V _{CC} = 4.5 V, I _{OH} = -3 mA			2.5			2.5		2.5		
.,	V _{CC} = 5 V, I _{OH} = -3 mA			3			3		3		
VOH	V _{CC} = 4.5 V,	I _{OH} = -24	ł mA	2			2				V
	V _{CC} = 4.5 V,	I _{OH} = - 32	2 mA	2‡					2		
.,	V _{CC} = 4.5 V,	I _{OL} = 48 r	nA			0.55		0.55			
VOL	V _{CC} = 4.5 V,	I _{OL} = 64 r	nA			0.55‡				0.55	V
	V _{CC} = 5.5 V,		Control inputs			±1		±1		±1	
I _I	$V_I = V_{CC}$ or GND		A or B ports			±100		±100		±100	μΑ
I _{OZH} §	$V_{CC} = 5.5 \text{ V}, \qquad V_{O} = 2.7 \text{ V}$					50		50		50	μΑ
I _{OZL} §	$V_{CC} = 5.5 \text{ V},$	V _O = 0.5 \	J			-50		-50		-50	μΑ
l _{off}	$V_{CC} = 0$,	V _I or V _O ≤	4.5 V			±100				±100	μΑ
ICEX	V _{CC} = 5.5 V, V _O = 5.5 V		Outputs high			50		50		50	μΑ
ΙΟ [¶]	V _{CC} = 5.5 V,	V _O = 2.5 \	J	-50	-100	-180	-50	-180	-50	-180	mA
	V _{CC} = 5.5 V,	A or B ports	Outputs high		1	250		250		250	μΑ
ICC	$I_{O} = 0$,		Outputs low		24	35		35		35	mA
	$V_I = V_{CC}$ or GND		Outputs disabled		0.5	250		250		250	μΑ
ΔI _{CC} #	V_{CC} = 5.5 V, One input at 3.4 V, Other inputs at V_{CC} or GND				1.5		1.5		1.5	mA	
C _i	V _I = 2.5 V or 0.5 V Control inputs			3.5						pF	
C _{io}	$V_O = 2.5 \text{ V or } 0.5 \text{ V}$ A or B ports			7.5						pF	

[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] On products compliant to MIL-STD-883, Class B, this parameter does not apply.

[§] The parameters IOZH and IOZL include the input leakage current.

[¶] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[#]This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

PRODUCT PREVIEW

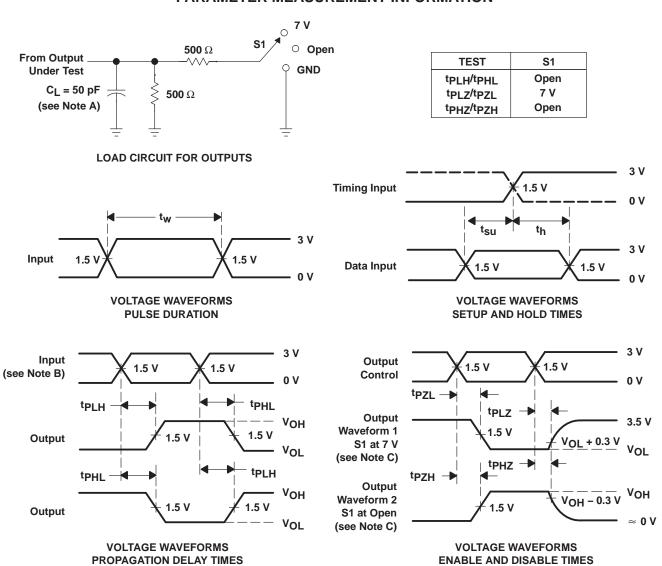
timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

				V _{CC} = 5 V, T _A = 25°C		SN54ABT2952		SN74ABT2952		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency			0	150	0	150	0	150	MHz
			CLK high	3		3		3		
t _W	Pulse duration		CLK low	3.5		3.5		3.5		ns
		A or B	High	4		4		4		
	Catum time hafara CLIVA		Low	3		3		3		
^t su	t _{SU} Setup time before CLK↑	·	High	3.5		3.5		3.5		ns
	CLKEN	Low	2.5		2.5		2.5			
t _h Hold time at	Hald time after OLKA	A or B		0		0		0		no
	Hold time after CLK	CLKEN	_	0		0		0		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C			SN54ABT2952		SN74ABT2952		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f _{max}			150			150		150		MHz
t _{PLH}	CLKAB or CLKBA	B or A								ns
t _{PHL}										
^t PZH	OEBA or OEAB	A or B								ns
^t PZL	OEBA OF OEAB	A or B								
^t PHZ	OEBA or OEAB	A or B								ns
t _{PLZ}	OEBA UI OEAB									110

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

INVERTING AND NONINVERTING OUTPUTS

B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq 2.5 \text{ ns.}$ tf \leq 2.5 ns.

LOW- AND HIGH-LEVEL ENABLING

- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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